

## **Product Change Notification / RMES-09AHZT744**

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11-Feb-2021

# **Product Category:**

Bluetooth Module

# **PCN Type:**

Manufacturing Change

# **Notification Subject:**

CCB 4347.001 Final Notice: Implement new packing material (JEDEC tray) and packing changes for selected RN41Nxxx module.

### **Affected CPNs:**

RMES-09AHZT744\_Affected\_CPN\_02112021.pdf RMES-09AHZT744\_Affected\_CPN\_02112021.csv

## **Notification Text:**

PCN Status: Final notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:** Implement new packing material (JEDEC tray) and packing changes for selected RN41Nxxx module.

#### Pre Change:

Plastic tray

#### Post Change:

JEDEC standard tray

Pre and Post Change Summary:

	Pre Change – Transparent Tray	Post Change – JEDEC Tray	
Tray Color	Transparent/Clear	Black	
No. modules per tray	64	84	
Base Quantity Multiple (BQM) Minimum order quantity	64 modules	84 modules	
Tray Dimension (WxLxH)	188 x 288 x 12.1 mm	135.9 x 322.6 x 7.62 mm	
Bakable @150 C, max	NO	YES	
Tray matrix	8 x 8	7 x 12	
Tray photos	See Pre and Post Change attachment for the photo		

Impacts to Data Sheet: None

Change Impact: None

**Reason for Change:** To improve manufacturability by qualifying JEDEC standard tray.

**Change Implementation Status:** In Progress

**Estimated First Ship Date:** 

February 26, 2021 (date code: 2109)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

### Time Table Summary:

	February 2021			
Workweek	06	07	08	09
Qual Report Availability		Χ		
Final PCN Issue Date		Χ		
Estimated Implementation Date				Х

Method to Identify Change: Traceability code and packing material

Qualification Report: Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:February 11, 2021:** Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on February 26, 2021.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## **Attachments:**

PCN\_RMES-09AHZT744\_Pre and Post Change Summary.pdf PCN\_RMES-09AHZT744\_Qual\_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

RN41NAPL-I/RM543 RN41NAPL-I/RM545 RN41NAPL-I/RM RN41N-I/RM

RN41N-I/RM615 RN41N-I/RM477

Date: Thursday, February 11, 2021